# USB-Compliant Single-Cell Li-Ion Switching Charger with USB-OTG Boost for 200 mA to 1.45 A Systems

# FAN54005

## Description

The FAN54005 is a highly integrated switch-mode charger, configurable for 200 mA to 1.45 A systems using a single external resistor.

The charging parameters and operating modes are programmable through an I<sup>2</sup>C Interface that operates up to 3.4 Mbps.

The charger and boost regulator circuits switch at 3 MHz to minimize the size of external passive components.

The FAN54005 provides battery charging in three phases: conditioning, constant current and constant voltage.

To ensure USB compliance and minimize charging time, the input current limit can be changed through the  $I^2C$  interface by the host processor. Charge termination is determined by a programmable minimum current level. A safety timer with reset control provides a safety backup for the  $I^2C$  host. Charge status is reported to the host through the  $I^2C$  port.

The integrated circuit (IC) automatically restarts the charge cycle when the battery falls below an internal threshold. If the input source is removed, the IC enters a high–impedance mode, preventing leakage from the battery to the input. Charge current is reduced when the die temperature reaches 120°C, protecting the device and PCB from damage.

The FAN54005 can operate as a boost regulator on command from the system. The boost regulator includes a soft-start that limits inrush current from the battery and uses the same external components used for charging the battery.

# Features

- Fully Integrated, High–Efficiency Charger for Single–Cell Li–Ion and Li–Polymer Battery Packs
- Charge Voltage Accuracy: ±0.5% at 25°C
  - ±1% from 0 to 125°C
- Supports 200 mA to 1.45 A Systems 95% Efficiency for 200 mA-Hour Batteries 94% Efficiency for 500 mA-Hour Batteries 90% Efficiency for 1.0 A-Hour Batteries
- ±5% Input Current Regulation Accuracy
- ±5% Charge Current Regulation Accuracy
- 20 V Absolute Maximum Input Voltage
- 6 V Maximum Input Operating Voltage



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- Charge Parameters Programmable through High–Speed I<sup>2</sup>C Interface (3.4 Mb/s) with Fast Mode Plus Compatibility
  - Input Current
  - Fast-Charge / Termination Current
  - Charger Voltage
  - Termination Enable
- 3 MHz Synchronous Buck PWM Controller with Wide Duty Cycle Range
- Small Footprint 1 µH External Inductor
- Safety Timer with Reset Control
- 1.8 V Regulated Output from VBUS for Auxiliary Circuits
- Dynamic Input Voltage Control Automatically Reduces Charging Current with Weak Input Sources
- Low Reverse Leakage to Prevent Battery Drain to VBUS
- 5 V, 500 mA Boost Mode for USB OTG for 3.0 V to 4.5 V Battery Input
- Available in a 1.96 x 1.87 mm, 20–bump, 0.4 mm Pitch WLCSP Package

# Applications

- Wireless Speakers, Headphones
- Cell Phones, Gaming Devices
- Toys, Drones, Digital Cameras
- IoT Devices
- E-Cigs, Vapes

# **ORDERING INFORMATION**

Part Number	Temperature Range	Package	PN Bits: IC_INFO[4:2]	Packing <sup>†</sup>
FAN54005UCX	–40°C to +85°C	20-Bump, Wafer-Level Chip-Scale Package (WLCSP), 0.4 mm Pitch, 1.96 x 1.87 mm	101	Tape and Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

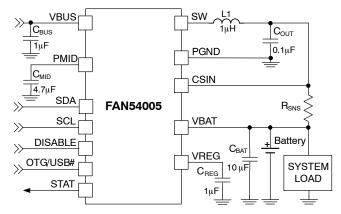
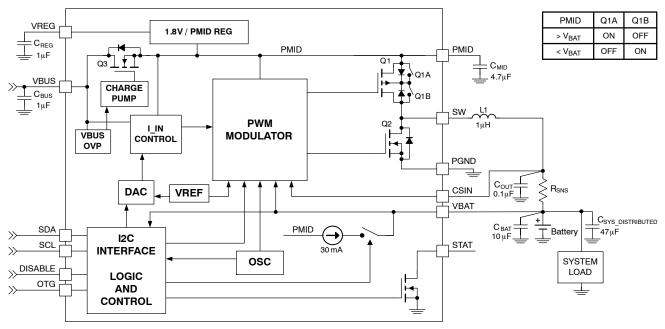


Figure 1. Typical Application







# Table 1. RECOMMENDED EXTERNAL COMPONENTS

Component	Description	Vendor	Parameter	Тур	Unit
L1	1 $\mu H$ ±20%, 4.0 A, 33 mΩ, 2016	Semco CIGT201610EH1R0M	L	1.0	μH
C <sub>BAT</sub>	10 μF, 20%, 6.3 V, X5R, 0603	Murata: GRM188R60J106M TDK: C1608X5R0J106M	С	10	μF
C <sub>MID</sub>	4.7 μF, 10%, 10 V, X5R, 0603	Murata: GRM188R61A475K TDK: C1608X5R1A475K	C (Note 1)	4.7	μF
C <sub>BUS</sub>	1.0 μF, 10%, 25 V, X5R, 0603	Murata: GRM188R61E105K TDK: C1608X5R1E105M	С	1.0	μF
C <sub>REG</sub>	1.0 μF, 10%, 10 V, X5R, 0402	Murata: GRM155R61A105K TDK: C1005X5R1A105K	С	1.0	μF
C <sub>OUT</sub>	0.1 μF, 10%, 16 V, X7R, 0402	Murata: GRM155R71C104K TDK: C1005X7R1C104K	С	0.1	μF
C <sub>SYS_DISTRIBUTED</sub> (Note 2)	n/a	n/a	С	47	μF

1. A 10 V rating is sufficient for CMID because PMID is protected from over-voltage surges on VBUS by Q3 (Figure 2).

2. A minimum 47 μF of distributed capacitance on SYS is required for proper operation of the FAN54005.

# Pin Configuration

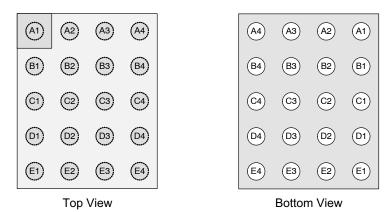


Figure 3. WLCSP-20 Pin Assignments

# Table 2. PIN DEFINITIONS

Pin #	Name	Description
A1, A2	VBUS	Charger Input Voltage and USB–OTG output voltage. Bypass with a 1 $\mu$ F capacitor to PGND.
A3	NC	No Connect. No external connection is made between this pin and the IC's internal circuitry.
A4	SCL	I <sup>2</sup> C Interface Serial Clock. This pin should not be left floating.
B1-B3	PMID	<b>Power Input Voltage.</b> Power input to the charger regulator, bypass point for the input current sense, and high-voltage input switch. Bypass with a minimum of 4.7 $\mu$ F, 6.3 V capacitor to PGND.
B4	SDA	I <sup>2</sup> C Interface Serial Data. This pin should not be left floating.
C1-C3	SW	Switching Node. Connect to output inductor.
C4	STAT	Status. Open-drain output indicating charge status. The IC pulls this pin LOW when charging.
D1-D3	PGND	<b>Power Ground.</b> Power return for gate drive and power transistors. The connection from this pin to the bottom of $C_{MID}$ should be as short as possible.
D4	OTG	<b>On-The-Go.</b> On VBUS Power-On Reset (POR), this pin sets the input current limit for t <sub>15MIN</sub> charging. Also, the OTG pin enables the boost regulator in conjunction with OTG_EN and OTG_PL bits (See Table 21)
E1	CSIN	<b>Current–Sense Input.</b> Connect to the sense resistor in series with the battery. The IC uses this node to sense current into the battery. Bypass this pin close to $R_{SNS}$ with a 0.1 $\mu$ F capacitor to PGND.
E2	DISABLE	<b>Charge Disable.</b> If this pin is HIGH, charging is disabled. When LOW, charging is controlled by the I <sup>2</sup> C registers. When this pin is HIGH, the 15-minute timer is reset. This pin does not affect the 32-second timer.
E3	VREG	<b>Regulator Output.</b> Connect to a 1 $\mu$ F capacitor to PGND. This pin provides regulated 1.8 V and can supply up to 2 mA of DC load current.
E4	VBAT	Battery Voltage. Connect to the positive (+) terminal of the battery pack and close to R <sub>SNS</sub> .

### Table 3. ABSOLUTE MAXIMUM RATINGS

Symbol		Parameter		Min Max		Unit
V <sub>BUS</sub>	VBUS Voltage	Continuous		-0.7	20.0	V
		Pulsed, 100 ms Maximum Non-Repetitive		-1.0		
V <sub>STAT</sub>	STAT Voltage			-0.3	16.0	V
VI	PMID Voltage				7.0	V
	SW, CSIN, VBAT, DISABLE Volta	ge		-0.3 (Note 3)	7.0	
Vo	Voltage on Other Pins			-0.3 6.5 (Note 4)		V
dV <sub>BUS</sub> / dt	Maximum V <sub>BUS</sub> Slope above 5.5	V when Boost or Char	ger are Active		4	V/μs
–dV <sub>BUS</sub> / dt	Negative VBUS Slew Rate during VBUS Short Circuit, $T_A \le 60^{\circ}C$			4	V/μs	
	$C_{MID} \le 4.7 \ \mu F$ (See VBUS Short V	vnile Charging)	$T_A \geq 60^\circ C$		2	
ESD	Electrostatic Discharge Protectior	ı Level	Human Body Model per JESD22-A114	20	00	V
			Charged Device Model per JESD22-C101	l 1000		
TJ	Junction Temperature		1	-40 +150		°C
T <sub>STG</sub>	Storage Temperature			-65	+150	°C
ΤL	Lead Soldering Temperature, 10 S	Seconds			+260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

3. SW only: Switching transients of -0.7 V, minimum, with duration <20 nsec, are acceptable.

4. Lesser of 6.5 V or  $\breve{V}_{I}$  + 0.3 V

#### **Table 4. RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter		Max	Unit
V <sub>BUS</sub>	Supply Voltage	4	6	V
V <sub>BAT(MAX)</sub>	Maximum Battery Voltage when Boost enabled		4.5	V
T <sub>A</sub>	Ambient Temperature	-30	+85	°C
TJ	Junction Temperature (See Thermal Regulation and Protection section)	-30	+120	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

# Table 5. THERMAL PROPERTIES

Symbol	Parameter		Unit
$\theta_{JA}$	Junction-to-Ambient Thermal Resistance	60	°C/W
$\theta_{JB}$	Junction-to-PCB Thermal Resistance	20	°C/W

NOTE: Junction-to-ambient thermal resistance is a function of application and board layout. This data is measured with four-layer 2s2p boards in accordance to JEDEC standard JESD51. Special attention must be paid not to exceed junction temperature T<sub>J(max)</sub> at a given ambient temperature T<sub>A</sub>. For measured data, see Thermal Regulation and Protection.

#### Table 6. ELECTRICAL SPECIFICATIONS

Unless otherwise specified: according to the circuit of Figure 1; recommended operating temperature range for  $T_J$  and  $T_A$ ;  $V_{BUS} = 5.0 \text{ V}$ ; HZ\_MODE; OPA\_MODE = 0; (Charge Mode); SCL, SDA, OTG = 0 or 1.8 V; and typical values are for  $T_J = 25^{\circ}$ C.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit					
POWER SU	POWER SUPPLIES										
I <sub>VBUS</sub>	VBUS Current	V <sub>BUS</sub> > V <sub>IN(MIN)1</sub> , PWM Switching		10		mA					
		V <sub>BUS</sub> > V <sub>IN(MIN)1</sub> ; PWM Enabled, Not Switching (Battery OVP Condition); I_IN Setting = 100 mA		2.5		mA					
		$0^{\circ}C < T_{J} < 85^{\circ}C, HZ_MODE = 1, 32S Mode$		63	90	μΑ					
I <sub>LKG</sub>	VBAT to VBUS Leakage Current	$0^\circ C < T_J < 85^\circ C, HZ\_MODE$ = 1, $V_{BAT}$ = 4.2 V, $V_{BUS}$ = 0 V		0.2	5.0	μΑ					
I <sub>BAT</sub>	Battery Discharge Current in High– Impedance Mode	$0^\circ C < T_J < 85^\circ C, HZ\_MODE$ = 1, $V_{BAT}$ = 4.2 V			10	μΑ					
		DISABLE = 1, 0°C < T <sub>J</sub> < 85°C, $V_{BAT}$ = 4.2 V			10						

#### CHARGER VOLTAGE REGULATION

V <sub>OREG</sub>	Charge Voltage Range		3.5	4.4	V
	Charge Voltage Accuracy	$T_A = 25^{\circ}C$	-0.5%	+0.5%	
		$T_{\rm J} = 0$ to 125°C	-1%	+1%	

### CHARGING CURRENT REGULATION

I <sub>OCHARGE</sub>	Output Charge Current Range	$V_{SHORT} < V_{BAT} < V_{OREG},$ 68 < $R_{SNS}$ < 180 m $\Omega$	200		1450	mA
	Charge Current Accuracy Across	$20 \text{ mV} \leq [V_{CSIN} - V_{BAT}] \leq 40 \text{ mV}$	92	97	102	%
	R <sub>SNS</sub>	$[V_{CSIN} - V_{BAT}] > 40 \text{ mV}$	94	97	100	%

#### WEAK BATTERY DETECTION

ſ	V <sub>LOWV</sub>	Weak Battery Threshold Range		3.4		3.7	V
		Weak Battery Threshold Accuracy		-5		+5	%
		Weak Battery Deglitch Time	Rising Voltage		30		ms

#### LOGIC LEVELS: DISABLE, SDA, SCL, OTG

V <sub>IH</sub>	High-Level Input Voltage		1.05			V
V <sub>IL</sub>	Low-Level Input Voltage				0.4	V
I <sub>IN</sub>	Input Bias Current	Input Tied to GND or V <sub>BUS</sub>		0.01	1.00	μA

#### **CHARGE TERMINATION DETECTION**

ITERM	Termination Current Range	$V_{BAT} > V_{OREG} - V_{RCH},$ 68 < R <sub>SNS</sub> < 180 m $\Omega$	20		400	mA
	Termination Current Accuracy	$[V_{CSIN}-V_{BAT}]$ from 3 mV to 20 mV	-25		+25	%
		$[V_{CSIN}-V_{BAT}]$ from 20 mV to 40 mV	-5		+5	
	Termination Current Deglitch Time			30		ms

#### **1.8 V LINEAR REGULATOR**

V <sub>REG</sub>	1.8 V Regulator Output	Regulator Output         I <sub>REG</sub> from 0 to 2 mA         1.7		1.8	1.9	V
INPUT POW	VER SOURCE DETECTION					
V <sub>IN(MIN)1</sub>	VBUS Input Voltage Rising	To Initiate and Pass VBUS Validation		4.29	4.42	V
V <sub>IN(MIN)2</sub>	Minimum VBUS During Charge	During Charging		3.71	3.94	V
t <sub>VBUS_VALID</sub>	VBUS Validation Time			30		ms

# DYNAMIC INPUT VOLTAGE CONTROL (V<sub>BUS</sub>) V<sub>SP</sub> DIVC Accuracy -3 +3 %

Table 6. ELECTRICAL SPECIFICATIONSUnless otherwise specified: according to the circuit of Figure 1; recommended operating temperature range for  $T_J$  and  $T_A$ ; $V_{BUS} = 5.0 V$ ; HZ\_MODE; OPA\_MODE = 0; (Charge Mode); SCL, SDA, OTG = 0 or 1.8 V; and typical values are for  $T_J = 25^{\circ}$ C.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
INPUT CUF	RENT LIMIT		-	-	-	
I <sub>INLIM</sub>	Input Current Limit Threshold	I <sub>INLIM</sub> Set to 100 mA	88	93	98	mA
		I <sub>INLIM</sub> Set to 500 mA	450	475	500	
BATTERY R	RECHARGE THRESHOLD					
V <sub>RCH</sub>	Recharge Threshold	Below V <sub>OREG</sub>	100	120	150	mV
	Deglitch Time	V <sub>BAT</sub> Falling Below V <sub>RCH</sub> Threshold		130		ms
STAT OUT	PUT					
V <sub>STAT(OL)</sub>	STAT Output Low	I <sub>STAT</sub> = 10 mA			0.4	V
I <sub>STAT(OH)</sub>	STAT High Leakage Current	V <sub>STAT</sub> = 5 V			1	μA
( )	DETECTION					
I <sub>DETECT</sub> Battery Detection Current before Charge Done (Sink Current) (Note 5)		Begins after Termination Detected and $V_{BAT} \leq V_{OREG} - V_{RCH}$		-0.80		mA
t <sub>DETECT</sub>	Battery Detection Time			262		ms
	MPARATOR	1		1	1	1
V <sub>SLP</sub>	Sleep–Mode Entry Threshold, $V_{BUS} - V_{BAT}$	$2.3 \text{ V} \leq \text{V}_{BAT} \leq \text{V}_{OREG}, \text{ V}_{BUS} \text{ Falling}$	0	0.04	0.10	V
t <sub>SLP_EXIT</sub>	Deglitch Time for VBUS Rising Above $V_{BAT}$ by $V_{SLP}$	Rising Voltage		30		ms
POWER SV	VITCHES (See Figure 2)	•		•		
R <sub>DS(ON)</sub>	Q3 On Resistance (VBUS to PMID)	I <sub>INLIM</sub> = 500 mA		180	250	m۵
	Q1 On Resistance (PMID to SW)			130	225	
	Q2 On Resistance (SW to GND)			150	225	
CHARGER	PWM MODULATOR				•	
f <sub>SW</sub>	Oscillator Frequency		2.7	3.0	3.3	MH
D <sub>MAX</sub>	Maximum Duty Cycle				100	%
D <sub>MIN</sub>	Minimum Duty Cycle			0		%
I <sub>SYNC</sub>	Synchronous to Non–Synchronous Current Cut–Off Threshold (Note 6)	Low–Side MOSFET (Q2) Cycle–by–Cycle Current Limit		140		mA
BOOST MC	DDE OPERATION (OPA_MODE = 1, HZ	MODE = 0)				
VBOOST	Boost Output Voltage at VBUS	2.5 V < V <sub>BAT</sub> < 4.5 V, I <sub>LOAD</sub> from 0 to 200 mA	4.80	5.07	5.17	V
00001		$3.0 \text{ V} < \text{V}_{BAT} < 4.5 \text{ V}, \text{ I}_{LOAD} \text{ from 0 to 500 mA}$	4.77	5.07	5.17	
BAT(BOOST)	Boost Mode Quiescent Current	PFM Mode, V <sub>BAT</sub> = 3.6 V, I <sub>OUT</sub> = 0		140	300	μA
ILIMPK(BST)	Q2 Peak Current Limit		1440	1700	1960	mA
UVLO <sub>BST</sub>	Minimum Battery Voltage for Boost	While Boost Active		2.30		V
501	Operation	To Start Boost Regulator		2.50	2.70	
VBUS LOA	L D RESISTANCE	··· · · · · · · · · · · · · · · ·				1
R <sub>VBUS</sub>	VBUS to PGND Resistance	Normal Operation		1500		kΩ
· • VBUS		Charger Validation		100	}	Ω
PROTECTI	ON AND TIMERS			100	1	52
VBUSOVP	VBUS Over-Voltage Shutdown	Vous Bising	6.09	6.29	6.49	V
* DOSOVP		V <sub>BUS</sub> Rising	0.09		0.49	
	Hysteresis	V <sub>BUS</sub> Falling		100		m∖

#### **Table 6. ELECTRICAL SPECIFICATIONS**

Unless otherwise specified: according to the circuit of Figure 1; recommended operating temperature range for  $T_J$  and  $T_A$ ;  $V_{BUS} = 5.0 \text{ V}; \text{ HZ_MODE}; \text{ OPA_MODE} = 0;$  (Charge Mode); SCL, SDA, OTG = 0 or 1.8 V; and typical values are for  $T_J = 25^{\circ}$ C.

Symbol	Parameter	Parameter Conditions		Тур	Мах	Unit
PROTECTI	ON AND TIMERS					
I <sub>LIMPK(CHG)</sub>	Q1 Cycle-by-Cycle Peak Current Limit	Charge Mode		2.3		A
V <sub>SHORT</sub>	V <sub>SHORT</sub> Battery Short-Circuit Threshold V <sub>BAT</sub> Rising		1.95	2.00	2.05	V
	Hysteresis	V <sub>BAT</sub> Falling		100		mV
I <sub>SHORT</sub>	Linear Charging Current	V <sub>BAT</sub> < V <sub>SHORT</sub>		30	40	mA
T <sub>SHUTDWN</sub>	Thermal Shutdown Threshold (Note 7)	T <sub>J</sub> Rising		145		°C
	Hysteresis (Note 7)	T <sub>J</sub> Falling		10		
T <sub>CF</sub>	Thermal Regulation Threshold (Note 7)	Charge Current Reduction Begins		120		°C
t <sub>INT</sub>	Detection Interval			2.1		s
t <sub>32S</sub>	32-Second Timer (Note 8)	Charger Enabled	20.5	25.2	28.0	S
		Charger Disabled	18.0	25.2	34.0	
t <sub>15MIN</sub>	15-Minute Timer	15-Minute Mode	12.0	13.5	15.0	min
$\Delta t_{LF}$	Low-Frequency Timer Accuracy	Charger Inactive	-25		25	%

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. Negative current is current flowing from the battery to GND (discharging the battery).

6. Q2 always turns on for 60 ns, then turns off if current is below I<sub>SYNC</sub>.

7. Guaranteed by design; not tested in production.

8. This tolerance (%) applies to all timers on the IC, including soft-start and deglitching timers.

### Table 7. I<sup>2</sup>C TIMING SPECIFICATIONS Guaranteed by design, $V_{BAT} \ge 2.5$ V if valid VBUS not present.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f <sub>SCL</sub>	SCL Clock Frequency	Standard Mode			100	kHz
		Fast Mode			400	1
		High–Speed Mode, $C_B \le 100 \text{ pF}$			3400	1
		High–Speed Mode, $C_B \le 400 \text{ pF}$			1700	
t <sub>BUF</sub>	Bus-Free Time between STOP and	Standard Mode		4.7		μs
START Conditions	START Conditions	Fast Mode		1.3		1
	START or Repeated START Hold	Standard Mode		4		μs
	Time	Fast Mode		600		ns
		High-Speed Mode		160		ns
t <sub>LOW</sub>	SCL LOW Period	Standard Mode		4.7		μs
		Fast Mode		1.3		μs
		High–Speed Mode, $C_B \le 100 \text{ pF}$		160		ns
		High–Speed Mode, $C_B \le 400 \text{ pF}$		320		ns
t <sub>HIGH</sub>	SCL HIGH Period	Standard Mode		4		μs
		Fast Mode		600		ns
		High–Speed Mode, $C_B \le 100 \text{ pF}$		60		ns
		High–Speed Mode, $C_B \le 400 \text{ pF}$		120		ns
t <sub>SU;STA</sub>	Repeated START Setup Time	Standard Mode		4.7		μs
		Fast Mode		600		ns
		High-Speed Mode		160		ns

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t <sub>SU;DAT</sub>	Data Setup Time	Standard Mode		250		ns
		Fast Mode		100		1
		High-Speed Mode		10		1
t <sub>HD;DAT</sub>	Data Hold Time	Standard Mode	0		3.45	μs
		Fast Mode	0		900	ns
		High–Speed Mode, $C_B \le 100 \text{ pF}$	0		70	ns
		High–Speed Mode, $C_B \le 400 \text{ pF}$	0		150	ns
t <sub>RCL</sub>	SCL Rise Time	Standard Mode	20+0	.1C <sub>B</sub>	1000	ns
		Fast Mode	20+0	.1C <sub>B</sub>	300	1
		High–Speed Mode, $C_B \le 100 \text{ pF}$		10	80	1
		High–Speed Mode, $C_B \le 400 \text{ pF}$		20	160	
t <sub>FCL</sub>	SCL Fall Time	Standard Mode	20+0	20+0.1C <sub>B</sub>		ns
		Fast Mode	20+0	20+0.1C <sub>B</sub>		1
		High–Speed Mode, $C_B \leq 100 \text{ pF}$		10	40	1
		High–Speed Mode, $C_B \leq 400 \text{ pF}$		20	80	1
t <sub>RDA</sub>	SDA Rise Time	Standard Mode	20+0	20+0.1C <sub>B</sub>		ns
t <sub>RCL1</sub>	Rise Time of SCL after a Repeated START Condition and after ACK Bit	Fast Mode	20+0	.1C <sub>B</sub>	300	1
		High–Speed Mode, $C_B \leq 100 \text{ pF}$		10	80	1
		High–Speed Mode, $C_B \leq 400 \text{ pF}$		20	160	1
t <sub>FDA</sub>	SDA Fall Time	Standard Mode	20+0	20+0.1C <sub>B</sub>		ns
		Fast Mode	20+0	.1C <sub>B</sub>	300	1
		High–Speed Mode, $C_B \leq 100 \text{ pF}$		10	80	1
		High–Speed Mode, $C_B \leq 400 \text{ pF}$		20	160	1
t <sub>SU;STO</sub>	Stop Condition Setup Time	Standard Mode		4		μs
		Fast Mode		600		ns
		High-Speed Mode		160		ns
CB	Capacitive Load for SDA, SCL				400	pF

Table 7. I <sup>2</sup> C TIMING SPECIFICATIONS Guaranteed by des	sign, $V_{BAT} \ge 2.5 \text{ V}$ if valid VBUS not present.
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# **Timing Diagrams**

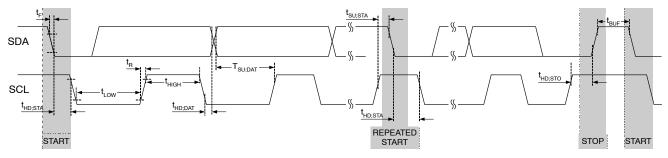
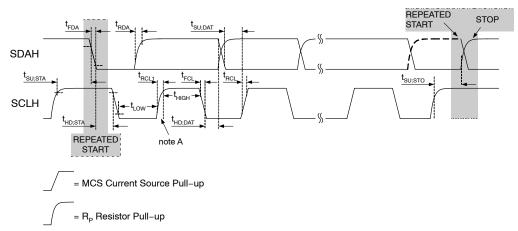


Figure 4. I<sup>2</sup>C Interface Timing for Fast and Slow Modes

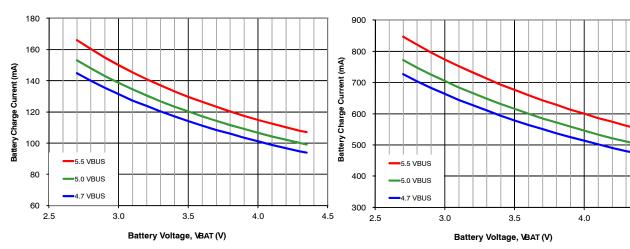


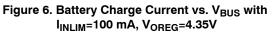
Note A: First rising edge of SCLH after Repeated Start and after each ACK bit.

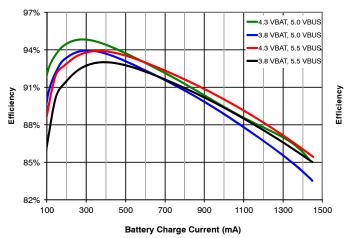
Figure 5. I<sup>2</sup>C Interface Timing for High–Speed Mode

# **Charge Mode Typical Characteristics**

Unless otherwise specified, circuit of Figure 1,  $R_{SNS}$  = 68 m $\Omega$ ,  $V_{OREG}$  = 4.2 V,  $V_{BUS}$  = 5.0 V, and  $T_A$  = 25°C.









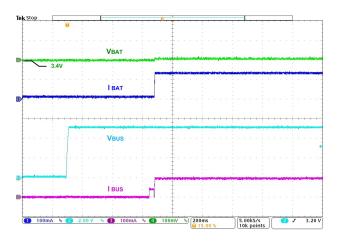


Figure 10. Auto-Charge Startup at VBUS Plug-in, OTG=0, V<sub>BAT</sub>=3.4 V

Figure 7. Battery Charge Current vs.  $V_{BUS}$  with  $I_{\rm INLIM}{=}500$  mA,  $V_{OREG}{=}4.35V$ 

4.5

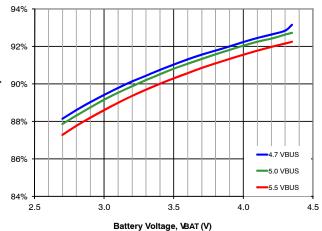
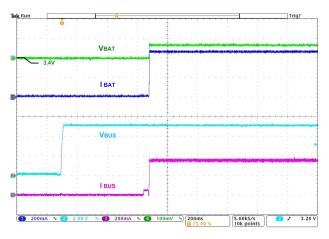
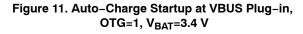


Figure 9. Charger Efficiency vs.  $V_{BUS}$ ,  $I_{INLIM}$ =500 mA,  $V_{OREG}$ =4.35





# **Charge Mode Typical Characteristics**

Unless otherwise specified, circuit of Figure 1,  $R_{SNS}$  = 68 m $\Omega$ ,  $V_{OREG}$  = 4.2 V,  $V_{BUS}$  = 5.0 V, and  $T_A$  = 25°C.

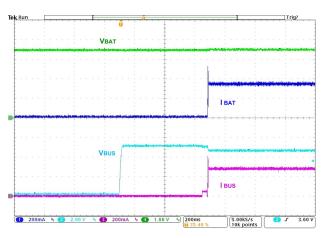


Figure 12. Auto-Charge Startup with 300 mA Limited Charger / Adaptor, OTG=1, V<sub>BAT</sub>=3.4 V

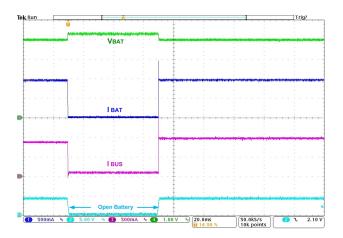


Figure 14. Battery Removal / Insertion During Charging, V\_{BAT}=3.9 V, I\_{OCHARGE}=1050 mA, No  $I_{INLIM},\,TE=0$ 

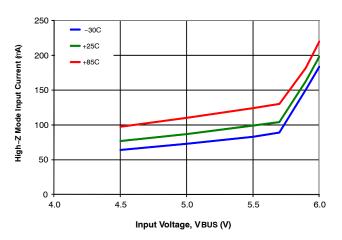


Figure 16. VBUS Current in High-Impedance Mode with Battery Open

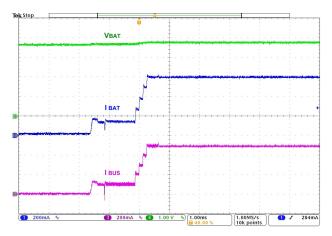


Figure 13. Charger Startup with HZ\_MODE Bit Reset, I<sub>INLIM</sub>=500 mA, I<sub>OCHARGE</sub>=1050 mA, V<sub>OREG</sub>=4.2 V, V<sub>BAT</sub>=3.6 V

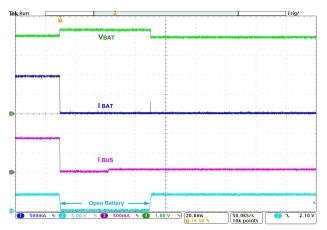


Figure 15. Battery Removal / Insertion During Charging, V\_{BAT}=3.9 V, I\_{OCHARGE}=1050 mA, No  $I_{INLIM},\,TE=1$ 

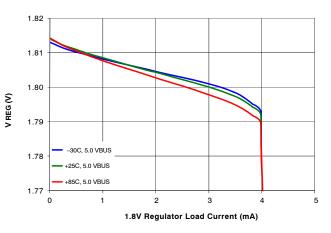


Figure 17. V<sub>REG</sub> 1.8 V Output Regulation

# **Charge Mode Typical Characteristics**

Unless otherwise specified, circuit of Figure 1,  $R_{SNS}$  = 68 m $\Omega$ ,  $V_{OREG}$  = 4.2 V,  $V_{BUS}$  = 5.0 V, and  $T_A$  = 25°C.

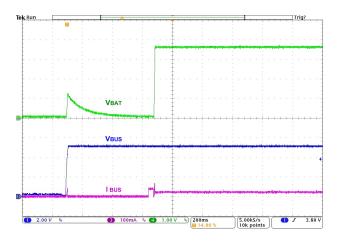


Figure 18. No Battery, TE=0, V<sub>BUS</sub> Power Up

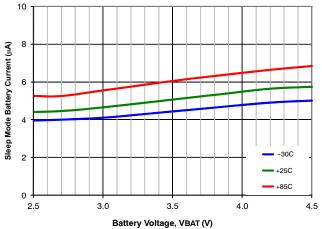


Figure 19. Sleep Mode Battery Discharge Current, SDA=SCL=0 V, VBUS Open

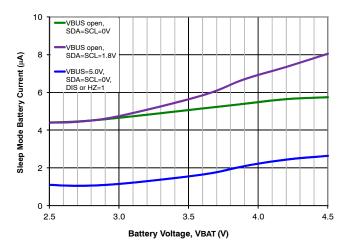
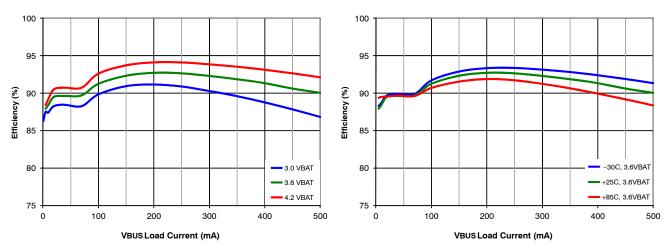
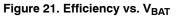


Figure 20. Battery Discharge Current vs. Mode

# **Boost Mode Typical Characteristics**

Unless otherwise specified, circuit of Figure 1,  $R_{SNS}$  = 68 m $\Omega,$   $V_{BAT}$  = 3.6 V, and  $T_A$  = 25°C.







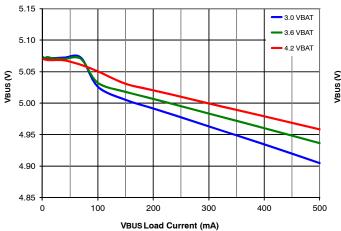


Figure 23. Output Regulation vs. V<sub>BAT</sub>

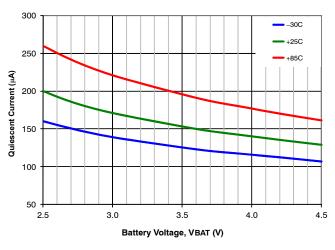


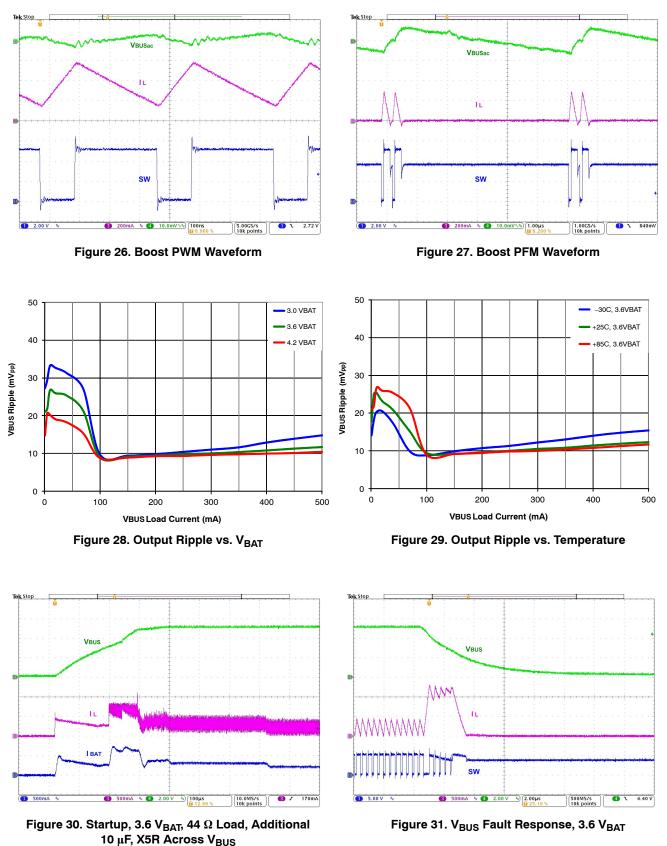
Figure 25. Quiescent Current

5.15 -30C, 3.6VBAT +25C, 3.6VBAT 5.10 +85C 3 6VBAT () \$5.05 \$100 5.00 4.95 4.90 4.85 0 100 200 300 400 500 VBUS Load Current (mA)

Figure 24. Output Regulation Over–Temperature

# **Boost Mode Typical Characteristics**

Unless otherwise specified, circuit of Figure 1,  $R_{SNS}$  = 68 m $\Omega,$   $V_{BAT}$  = 3.6 V, and  $T_A$  = 25°C.



# **Boost Mode Typical Characteristics**

Unless otherwise specified, circuit of Figure 1,  $R_{SNS}$  = 68 m $\Omega,$   $V_{BAT}$  = 3.6 V, and  $T_A$  = 25°C.

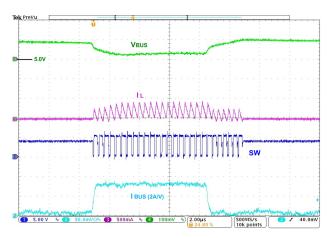


Figure 32. Load Transient, 5–155–5 mA, t<sub>R</sub>=t<sub>F</sub>=100 ns

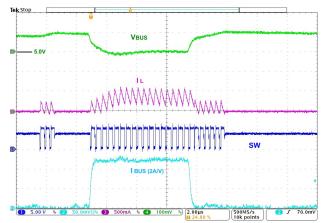


Figure 33. Load Transient, 5-255-5 mA, t<sub>R</sub>=t<sub>F</sub>=100 ns

# **Circuit Description / Overview**

When charging batteries with a current–limited input source, such as USB, a switching charger's high efficiency over a wide range of output voltages minimizes charging time.

The FAN54005 combines a highly integrated synchronous buck regulator for charging with a synchronous boost regulator, which can supply 5 V to USB On–The–Go (OTG) peripherals. The FAN54005 employs synchronous rectification for both the charger and boost regulators to maintain high efficiency over a wide range of battery voltages and charge states.

The FAN54005 has three operating modes:

- 1. Charge Mode: Charges a single-cell Li-ion or Li-polymer battery.
- 2. Boost Mode: Provides 5 V power to USB–OTG with an integrated synchronous rectification boost regulator using the battery as input.
- 3. High–Impedance Mode: Both the boost and charging circuits are OFF in this mode. Current flow from VBUS to the battery or from the battery to VBUS is blocked in this mode. This mode consumes very little current from VBUS or the battery.

# **Charge Mode and Registers**

Note: Default settings are denoted by **bold typeface**.

# **Charge Mode**

In Charge Mode, FAN54005 employs four regulation loops:

- 1. Input Current: Limits the amount of current drawn from VBUS. This current is sensed internally and can be programmed through the I<sup>2</sup>C interface.
- Charging Current: Limits the maximum charging current, which is sensed using an external R<sub>SNS</sub>. Choose R<sub>SNS</sub> to provide the desired I<sub>OCHARGE</sub> and I<sub>TERM</sub> currents for your system, relative to the V<sub>RSNS</sub> levels determined by the I<sub>OCHARGE</sub> and I<sub>TERM</sub> register settings, as shown in Table 4 and Table 5, respectively.
- 3. Charge Voltage: The regulator is restricted from exceeding this voltage. As the internal battery voltage rises, the battery's internal impedance and R<sub>SNS</sub> work in conjunction with the charge voltage regulation to decrease the amount of current flowing to the battery. Battery charging is completed when the voltage across R<sub>SNS</sub> drops below the threshold determined by I<sub>TERM</sub>.
- 4. Temperature: If the IC's junction temperature reaches 120°C, charge current is reduced until the IC's temperature stabilizes at 120°C.
- 5. Dynamic Input Voltage Control (DIVC) limits the amount of drop on VBUS to a programmable voltage ( $V_{SP}$ ) to accommodate incompatible adapters that limit current to a lower current than might be available from a "normal" USB adapter.

## Battery Charging Curve

If the battery voltage is below  $V_{SHORT}$ , a linear current source pre-charges the battery until  $V_{BAT}$  reaches  $V_{SHORT}$ . The PWM charging circuit is then started and the battery is charged with a constant current if sufficient input power is available. The current slew rate is limited to prevent overshoot.

During the current regulation phase of charging,  $I_{INLIM}$  or the programmed charging current limits the amount of current available to charge the battery and power the system. The effect of  $I_{INLIM}$  on  $I_{OCHARGE}$  can be seen in Figure 35.

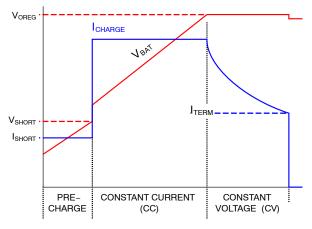


Figure 34. Charge Curve, I<sub>OCHARGE</sub> Not Limited by I<sub>INLIM</sub>

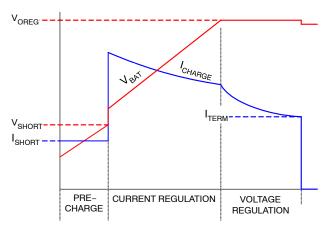


Figure 35. Charge Curve, I<sub>INLIM</sub> Limits I<sub>OCHARGE</sub>

Assuming that  $V_{OREG}$  is programmed to the cell's fully charged "float" voltage, the current that the battery accepts with the PWM regulator limiting its output (sensed at VBAT) to  $V_{OREG}$  declines, and the charger enters the voltage regulation phase of charging. When the current declines to the programmed I<sub>TERM</sub> value, the charge cycle is complete. Charge current termination can be disabled by resetting the TE bit (REG 01[3]).

The charger output or "float" voltage can be programmed by the OREG bits from 3.5 V to 4.44 V in 20 mV increments as shown in Table 8.

# Table 8. OREG BITS (REG 02[7:2]) vs. CHARGER $V_{OUT} \; (V_{OREG}) \; FLOAT \; VOLTAGE$

Decimal	Hex	V <sub>OREG</sub>		Decimal	Hex	V <sub>OREG</sub>
OREG		L				
0	00	3.50		32	20	4.14
1	01	3.52	ľ	33	21	4.16
2	02	3.54	ľ	34	22	4.18
3	03	3.56	ľ	35	23	4.20
4	04	3.58	ľ	36	24	4.22
5	05	3.60	ĺ	37	25	4.24
6	06	3.62	ĺ	38	26	4.26
7	07	3.64	ĺ	39	27	4.28
8	08	3.66	ĺ	40	28	4.30
9	09	3.68	ľ	41	29	4.32
10	0A	3.70	ĺ	42	2A	4.34
11	0B	3.72	ľ	43	2B	4.36
12	0C	3.74	ĺ	44	2C	4.38
13	0D	3.76	ľ	45	2D	4.40
14	0E	3.78	ľ	46	2E	4.42
15	0F	3.80	ĺ	47	2F	4.44
16	10	3.82	ľ	48	30	4.44
17	11	3.84	ľ	49	31	4.44
18	12	3.86	ĺ	50	32	4.44
19	13	3.88	ĺ	51	33	4.44
20	14	3.90	ľ	52	34	4.44
21	15	3.92	ľ	53	35	4.44
22	16	3.94	ľ	54	36	4.44
23	17	3.96	ľ	55	37	4.44
24	18	3.98	ľ	56	38	4.44
25	19	4.00	ľ	57	39	4.44
26	1A	4.02	ĺ	58	ЗA	4.44
27	1B	4.04	ľ	59	3B	4.44
28	1C	4.06	ĺ	60	зC	4.44
29	1D	4.08	ĺ	61	3D	4.44
30	1E	4.10	ľ	62	3E	4.44
31	1F	4.12		63	ЗF	4.44

The following charging parameters can be programmed by the host through  $I^2C$ :

Parameter	Name	Register
Output Voltage Regulation	V <sub>OREG</sub>	REG 02[7:2]
Battery Charging Current Limit	IOCHARGE	REG 04[6:4]
Input Current Limit	I <sub>INLIM</sub>	REG 01[7:6]
Charge Termination Limit	I <sub>TERM</sub>	REG 04[2:0]
Weak Battery Voltage	V <sub>LOWV</sub>	REG 01[5:4]

A new charge cycle begins when one of the following occurs:

- The battery voltage falls below  $V_{OREG} V_{RCH}$
- VBUS Power on Reset (POR)
- CE or HZ\_MODE is reset through I<sup>2</sup>C write to CONTROL1 (REG 01) register.

# Charge Current Limit (I<sub>OCHARGE</sub>)

Charge current limit is established by regulating the voltage across  $R_{SNS}$  ( $V_{RSNS}$ ) to the value controlled by the IOCHARGE bits. Select  $R_{SNS}$  in the range of 68 m $\Omega$  <  $R_{SNS}$  < 180 m $\Omega$ .

Charge current is further limited by the IO\_LEVEL (Reg 05[5]) bit by default (IO\_LEVEL=1). When IOLEVEL=1, the voltage across  $R_{SNS}$  is limited to 34.0 mV. When IO\_LEVEL=0 charge current is limited by the IOCHARGE bits.

			I <sub>OCHARGE</sub> Range (mA)				
Decimal	HEX	V <sub>RSNS</sub> (mV)	180 mΩ	68 mΩ			
IOCHARGE							
0	00	37.4	208	550			
1	01	44.2	246	650			
2	02	51.0	283	750			
3	03	57.8	321	850			
4	04	71.4	397	1050			
5	05	78.2	434	1150			
6	06	91.8	510	1350			
7	07	98.6	548	1450			

# Table 10. I<sub>OCHARGE</sub> CURRENT AS FUNCTION OF I<sub>OCHARGE</sub> (REG 04 [6:4]) BITS AND $R_{SNS}$ VALUE

# **Termination Current Limit**

Current charge termination is enabled when TE (REG 01[3])=1.

			I <sub>TERM</sub> Range (mA)	
Decimal	HEX	V <sub>RSNS</sub> (mV)	180 m $\Omega$	68 mΩ
ITERM				
0	00	3.3	18	49
1	01	6.6	37	97
2	02	9.9	55	146
3	03	13.2	73	194
4	04	16.5	92	243
5	05	19.8	110	291
6	06	23.1	128	340
7	07	26.4	147	388

# Table 11. I<sub>TERM</sub> CURRENT AS FUNCTION OF ITERM BITS (REG 04[2:0]) AND $R_{SNS}$ RESISTOR VALUES

When the charge current falls below  $I_{TERM}$ , PWM charging stops and the STAT bits change to READY (00) for about 500 ms while the IC determines whether the battery and charging source are still connected. STAT then changes to CHARGE DONE (10), provided the battery and charger are still connected.

#### PWM Controller in Charge Mode

The IC uses a current-mode PWM controller to regulate the output voltage and battery charge currents. The synchronous rectifier (Q2) has a current limit that switches off the FET when the current is more negative than  $I_{SYNC}$ .

# **Charger Operation**

# V<sub>BUS</sub> Plug In

When the IC detects that  $V_{BUS}$  has risen above  $V_{IN(MIN)1}$  (4.4 V), the IC applies a 100  $\Omega$  load from VBUS to GND. To clear the VBUS Power–On–Reset (POR) and begin charging, VBUS must remain above  $V_{IN(MIN)1}$  and below VBUS<sub>OVP</sub> for t<sub>VBUS\_VALID</sub> (30 ms) before the IC initiates charging.

The VBUS validation sequence always occurs before charging is initiated or re–initiated (for example, after a VBUS OVP fault or a  $V_{RCH}$  recharge initiation).

 $T_{VBUS_VALID}$  ensures that unfiltered 50 / 60 Hz chargers and other non-compliant chargers are rejected.

# Safety Timer

Section references Figure 39.

At the beginning of charging, the IC starts a 15-minute timer ( $t_{15MIN}$ ). When this times out, charging is terminated. Writing to any register through I<sup>2</sup>C stops and resets the  $t_{15MIN}$  timer, which in turn starts a 32-second timer ( $t_{32S}$ ). Setting the TMR\_RST bit (REG 00[7]) resets the  $t_{32S}$  timer. If the  $t_{32S}$  timer times out; charging is terminated, all registers (except Safety) are set to their default values, the FAULT bits are set to 110, STAT is pulsed HIGH and returns

LOW, and charging resumes using the default values with the  $t_{15MIN}$  timer running.

Normal charging is controlled by the host with the  $t_{32S}$  timer running to ensure that the host is alive. Charging with the  $t_{15MIN}$  timer running is used for charging that is unattended by the host. If the  $t_{15MIN}$  timer expires; the IC turns off the charger, sets the  $\overline{CE}$  bit, and indicates a timer fault (110) on the FAULT bits (REG 00[2:0]). This sequence prevents overcharge if the host fails to reset the  $t_{32S}$  timer.

## **USB-Friendly Boot Sequence**

At VBUS POR, the IC operates in accordance with its I<sup>2</sup>C register settings. If no registers have been written (including Safety, and the TMR\_RST bit), typically due to an absence of host communication, the chargers input current limit is controlled by the OTG pin (100 mA if OTG is LOW and 500 mA if OTG is HIGH).

Once the host processor begins writing to the IC, charging parameters are set by the host, which must continually reset the  $t_{32S}$  timer to continue charging using the programmed charging parameters.

### Input Current Limiting

To minimize charging time without overloading VBUS current limitations, the IC's input current limit can be programmed by the IINLIM bits (REG 01[7:6]).

Table 12.	INPUT	CURRENT	LIMIT
-----------	-------	---------	-------

IINLIM REG 01[7:6]	Input Current Limit
00	100 mA
01	500 mA
10	800 mA
11	No limit

The OTG pin establishes the input current limit when  $t_{15MIN}$  is running.

**Flow Charts** 

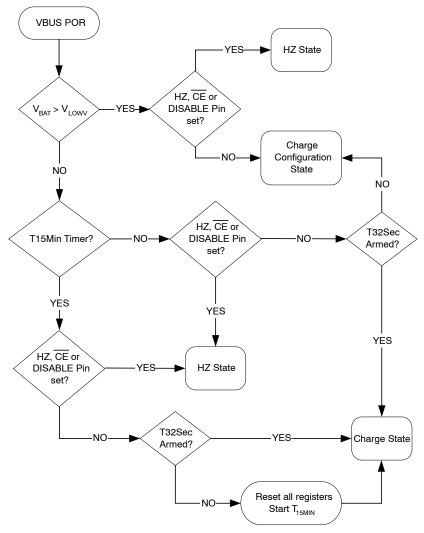


Figure 36. Charger VBUS POR

# Flow Charts (Continued)

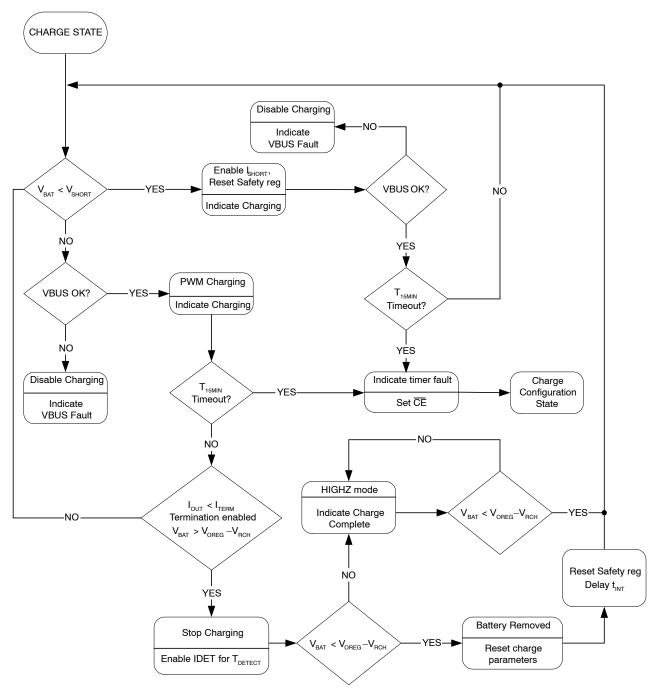
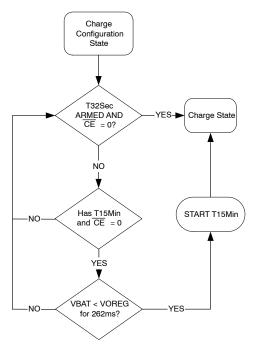


Figure 37. Charge Mode

# Flow Charts (Continued)





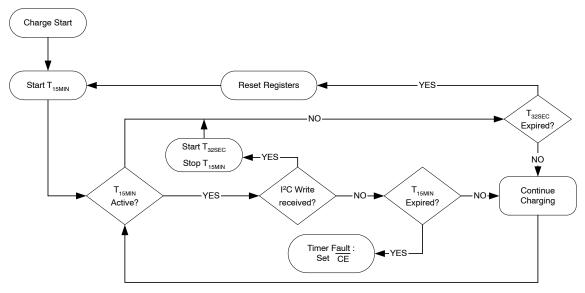


Figure 39. Timer Flow Chart

# **Dynamic Input Voltage Control**

The FAN54005 has functionality that limits input current in case a current–limited incompatible adapter is supplying VBUS. These slowly increase the charging current until either:

- I<sub>INLIM</sub> or I<sub>OCHARGE</sub> is reached
- or
- V<sub>BUS</sub>=V<sub>SP</sub>.

If  $V_{BUS}$  collapses to  $V_{SP}$  when the current is ramping up, the FAN54005 charges with an input current that keeps  $V_{BUS}=V_{SP}$  When the  $V_{SP}$  control loop is limiting the charge current, the SP bit (REG 05[4]) is set.

Decimal	HEX	V <sub>SP</sub>
VS	SP	
0	00	4.213
1	01	4.293
2	02	4.373
3	03	4.453
4	04	4.533
5	05	4.613
6	06	4.693
7	07	4.773

#### Table 13. V<sub>SP</sub> AS FUNCTION OF VSP BITS (REG 05[2:0])

#### Safety Settings

FAN54005 contain a SAFETY register (REG 06) that prevents the values in OREG (REG 02[7:2]) and IOCHARGE (REG 04[6:4]) from exceeding the values of the VSAFE and ISAFE values. Refer to Table 14 and Table 15 for details.

After  $V_{BAT}$  exceeds  $V_{SHORT}$ , the SAFETY register is loaded with its default value and may be written only before any other register is written. The entire desired Safety register value should be written twice to ensure the register bits are set. After writing to any other register, the SAFETY register is locked until  $V_{BAT}$  falls below  $V_{SHORT}$ .

The ISAFE (REG 06[6:4]) and VSAFE (REG 06[3:0]) registers establish the maximum values of  $V_{RSNS}$  and  $V_{OREG}$  used by the control logic. If the host attempts to write a value higher than VSAFE or ISAFE to OREG or IOCHARGE, respectively; the VSAFE, ISAFE value appears as the OREG, IOCHARGE register value, respectively.

Table 14. I<sub>SAFE</sub> (I<sub>OCHARGE</sub> Limit) AS FUNCTION OF ISAFE BITS (REG 06[6:4])

			I <sub>SAFE</sub> Range (mA)	
Decimal	HEX	V <sub>RSNS</sub> (mV)	180 mΩ	68 mΩ
IS	AFE			
0	00	37.4	208	550
1	01	44.2	246	650
2	02	51.0	283	750
3	03	57.8	321	850
4	04	71.4	397	1050
5	05	78.2	434	1150
6	06	91.8	510	1350
7	07	98.6	548	1450

Table 15. V <sub>SAFE</sub> (V <sub>OREG</sub> Max. Limit) AS FUNCTION
OF VSAFE BITS (REG 06[3:0])

Decimal	HEX	Max. OREG (REG 02[7:2])	V <sub>OREG</sub> Max. (V)
VSA	FE		
0	00	100011	4.20
1	01	100100	4.22
2	02	100101	4.24
3	03	100110	4.26
4	04	100111	4.28
5	05	101000	4.30
6	06	101001	4.32
7	07	101010	4.34
8	08	101011	4.36
9	09	101100	4.38
10	0A	101101	4.40
11	0B	101110	4.42
12	0C	101111	4.44
13	0D	110000	4.44
14	0E	110001	4.44
15	0F	110010	4.44

#### **Thermal Regulation and Protection**

When the IC's junction temperature reaches  $T_{CF}$  (about 120°C), the charger reduces its output current to 37.4 mV/R<sub>SNS</sub> to prevent overheating. If the temperature increases beyond  $T_{SHUTDOWN}$ ; charging is suspended, the FAULT bits are set to 101, and STAT is pulsed HIGH. In Suspend Mode, all timers stop and the state of the IC's logic is preserved. Charging resumes at programmed current after the die cools to about 120°C.

Additional  $\theta_{JA}$  data points, measured using the FAN54005 evaluation board, are given in Table 16 (measured with  $T_A=25^{\circ}C$ ). Note that as power dissipation increases, the effective  $\theta_{JA}$  decreases due to the larger difference between the die temperature and ambient.

Table 16	. EVALUATION	BOARD	MEASURED	$\theta_{JA}$
----------	--------------	-------	----------	---------------

Dissipation (W)	$\theta_{JA}$
0.504	54°C/W
0.844	50°C/W
1.506	46°C/W

# **Charge Mode Input Supply Protection**

# Sleep Mode

When  $V_{BUS}$  falls below  $V_{BAT} + V_{SLP}$  and  $V_{BUS}$  is above  $V_{IN(MIN)1}$ , the IC enters Sleep Mode to prevent the battery from draining into VBUS. During Sleep Mode, reverse current is disabled by body switching Q1.

# Input Supply Low–Voltage Detection

The IC continuously monitors VBUS during charging. If  $V_{BUS}$  falls below  $V_{IN(MIN)2}$ , the IC:

- 1. Terminates charging
- 2. Pulses the STAT pin, sets the STAT bits to 11, and sets the FAULT bits to 011.

If  $V_{BUS}$  recovers above the  $V_{IN(MIN)1}$  rising threshold after time  $t_{INT}$  (about two seconds), the charging process is repeated. This function prevents the USB power bus from collapsing or oscillating when the IC is connected to a suspended USB port or a low-current-capable OTG device.

# Input Over–Voltage Detection

When V<sub>BUS</sub> exceeds VBUS<sub>OVP</sub>, the IC:

- 1. Turns off Q3
- 2. Suspends charging
- 3. Sets the FAULT bits to 001, sets the STAT bits to 11, and pulses the STAT pin.

When  $V_{BUS}$  falls about 100 mV below VBUS<sub>OVP</sub>, the fault is cleared and charging resumes after  $V_{BUS}$  is revalidated.

# **VBUS Short While Charging**

If VBUS is shorted with a very low impedance while the IC is charging with  $I_{INLIMIT}$ =100 mA, the IC may not meet datasheet specifications until power is removed. To trigger this condition,  $V_{BUS}$  must be driven from 5 V to GND with a high slew rate. Achieving this slew rate requires a 0  $\Omega$  short from GND to the USB cable that is less than 10 cm from the connector.

# **Charge Mode Battery Detection & Protection**

# VBAT Over-Voltage Protection

The OREG voltage regulation loop prevents  $V_{BAT}$  from overshooting the OREG voltage by more than 50 mV when the battery is removed. When the PWM charger runs with no battery, the TE bit is not set, and a battery is inserted that is charged to a voltage higher than  $V_{OREG}$ ; PWM pulses stop. If no further pulses occur for 30 ms, the IC sets the FAULT bits to 100, sets the STAT bits to 11, and pulses the STAT pin.

# **Battery Detection during Charging**

The IC can detect the presence, absence, or removal of a battery if the termination bit (TE) is set. During normal charging, once  $V_{BAT}$  is close to  $V_{OREG}$  and the termination charge current is detected, the IC terminates charging and sets the STAT bits to 10. It then turns on a discharge current, I<sub>DETECT</sub>, for t<sub>DETECT</sub>. If  $V_{BAT}$  is still above  $V_{OREG} - V_{RCH}$ , the battery is present and the IC sets the FAULT bits to 000.

If  $V_{BAT}$  is below  $V_{OREG} - V_{RCH}$ , the battery is absent and the IC:

- 1. Sets the registers to their default values.
- 2. Sets the FAULT bits to 111.
- 3. Resumes charging with default values after  $t_{INT}$ .

# **Battery Short-Circuit Protection**

If the battery voltage is below the short–circuit threshold ( $V_{SHORT}$ ); a linear current source,  $I_{SHORT}$ , supplies  $V_{BAT}$  until  $V_{BAT} > V_{SHORT}$ .

# System Operation with No Battery

The FAN54005 continues charging after VBUS POR with the default parameters, regulating the  $V_{BAT}$  line to 3.54 V until the host processor issues commands or the  $t_{15MIN}$  timer expires. In this way, the FAN54005 can start the system without a battery.

The FAN54005 soft-start function may interfere with the system supply when the battery is absent. The soft-start activates whenever  $V_{OREG}$ ,  $I_{INLIM}$ , or  $I_{OCHARGE}$  are set from a lower to higher value. During soft-start, the  $I_{IN}$  limit drops to 100 mA for about 1 ms unless IINLIM is set to 11 (no limit). This could cause the system processor to fail to start. To avoid this behavior, use the following sequence.

- 1. Set the OTG pin HIGH. When VBUS is plugged in,  $I_{INLIM}$  is set to 500 mA until the system processor powers up and can set parameters through  $l^2C$ .
- 2. Program the Safety Register.
- 3. Set IINLIM to 11 (no limit).
- 4. Set OREG to the desired value (typically 4.18).
- 5. Reset the IO\_LEVEL bit, then set IOCHARGE.
- 6. Set I<sub>INLIM</sub> to 500 mA if a USB source is connected.

During the initial system startup, while the charger IC is being programmed, the system current is limited to 500 mA for 1 ms during steps 4 and 5. This is the value of the soft–start  $I_{OCHARGE}$  current used when  $I_{INLIM}$  is set to No Limit.

If the system is powered up without a battery present, the CV bit should be set. When a battery is inserted, the CV bit is cleared.

# Charger Status / Fault Status

The STAT pin indicates the operating condition of the IC and provides a fault indicator for interrupt driven systems.

# Table 17. STAT PIN FUNCTION

EN_STAT	Charge State	STAT Pin
0	Х	OPEN
Х	Normal Conditions	OPEN
1	Charging	LOW
х	Fault (Charging or Boost)	128 μs Pulse, then OPEN

The FAULT bits (REG 00[2:0]) indicate the type of fault in Charge Mode. See Table 18 for details.

Fault Bit		t	
B2	B1	B0	Fault Description
0	0	0	Normal (No Fault)
0	0	1	VBUS OVP
0	1	0	Sleep Mode
0	1	1	Poor Input Source
1	0	0	Battery OVP
1	0	1	Thermal Shutdown
1	1	0	Timer Fault
1	1	1	No Battery

# Table 18. FAULT STATUS BITS DURING CHARGE MODE

### **Charge Mode Control Bits**

Setting either HZ\_MODE or  $\overline{CE}$  through I<sup>2</sup>C disables the charger and puts the IC into High–Impedance Mode. The t<sub>32S</sub> timer will continue to run. If it is allowed to expire, all registers (except SAFETY) reset, which enables t<sub>15MIN</sub> charging. When the t<sub>15MIN</sub> expires, the IC sets the  $\overline{CE}$  bit and the IC enters High–Impedance Mode. If  $\overline{CE}$  was set by t<sub>15MIN</sub> overflow, a new charge cycle can only be initiated through I<sup>2</sup>C or VBUS POR.

Setting the RESET bit clears all registers (except Safety).

Table 19. DISABLE PIN AND CE BIT FUNCT	IONALITY
--	----------

Charging	DISABLE Pin	CE	HZ_MODE
ENABLE	0	0	0
DISABLE	Х	1	х
DISABLE	Х	Х	1
DISABLE	1	Х	х

Raising the DISABLE pin does stop the  $t_{32S}$  from advancing. If the DISABLE pin is raised during  $t_{15MIN}$  charging, the  $t_{15MIN}$  timer is reset.

# **Operational Mode Control**

OPA\_MODE (REG 01[0]) and the HZ\_MODE (REG 01[1]) bits in conjunction with the FAULT state define the operational mode of the charger.

HZ_MODE	OPA_MODE	FAULT	Operation Mode		
0	0	0	Charge		
0	Х	1	Charge Configure		
0	1	0	Boost		
1	Х	Х	High Impedance		

Table 20. OPERATION MODE CONTROL

The IC resets the OPA\_MODE bit whenever the boost is deactivated, whether due to a fault or being disabled by setting the HZ\_MODE bit.

## Boost Mode

Boost Mode can be enabled if the IC is in 32–Second Mode with the OTG pin and OPA\_MODE bits as indicated in Table 21. The OTG pin ACTIVE state is 1 if OTG\_PL=1 and 0 when OTG\_PL=0.

If boost is active using the OTG pin, Boost Mode is initiated even if the HZ\_MODE=1. The HZ\_MODE bit overrides the OPA\_MODE bit.

OTG_EN	OTG Pin	HZ_MODE	OPA_MODE	BOOST					
1	ACTIVE	Х	Х	Enabled					
Х	Х	0	1	Enabled					
Х	ACTIVE	Х	0	Disabled					
0	Х	1	Х	Disabled					
1	ACTIVE	1	1	Disabled					
0	ACTIVE	0	0	Disabled					

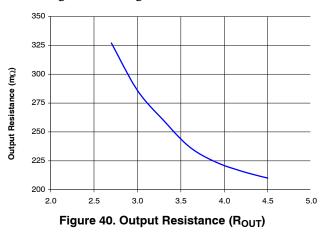
Tabla	01			POOST
laple	21.	ENAB	LING	BOOST

To remain in Boost Mode, the TMR\_RST must be set by the host before the  $t_{32S}$  timer times out. If  $t_{32S}$  times out in Boost Mode; the IC resets all registers, pulses the STAT pin, sets the FAULT bits to 110, and resets the BOOST bit. VBUS POR or reading REG00 clears the fault condition.

# **Boost PWM Control**

The IC uses a minimum on-time and computed minimum off-time to regulate VBUS. The regulator achieves excellent transient response by employing current-mode modulation. This technique causes the regulator to exhibit a load line. During PWM Mode, the output voltage drops slightly as the input current rises. With a constant  $V_{BAT}$ , this appears as a constant output resistance.

The "droop" caused by the output resistance when a load is applied allows the regulator to respond smoothly to load transients with no undershoot from the load line. This can be seen in Figure 32 and Figure 40.



 $V_{BUS}$  as a function of  $I_{LOAD}$  can be computed when the regulator is in PWM Mode (continuous conduction) as:

$$V_{BUS} = 5.07 - R_{OUT} \cdot I_{LOAD} \qquad (eq. 1)$$

At  $V_{BAT}$ =3.3 V, and  $I_{LOAD}$ =200 mA,  $V_{BUS}$  would drop to:

$$V_{BUS} = 5.07 - 0.26 \cdot 0.2 = 5.018 V$$
 (eq. 2)

At  $V_{BAT}$ =2.7 V, and  $I_{LOAD}$ =200 mA,  $V_{BUS}$  would drop to:

 $V_{BUS} = 5.07 - 0.327 \cdot 0.2 = 5.005 V$  (eq. 3)

#### **PFM Mode**

If  $V_{BUS} > V_{BOOST}$  (nominally 5.07 V) when the minimum off-time has ended, the regulator enters PFM Mode. Boost pulses are inhibited until  $V_{BUS} < V_{BOOST}$ . The minimum on-time is increased to enable the output to pump up sufficiently with each PFM boost pulse. Therefore the regulator behaves like a constant on-time regulator, with the bottom of its output voltage ripple at 5.07 V in PFM Mode.

Mode	Description	Invoked When
LIN	Linear Startup	$V_{BAT} > V_{BUS}$
SS	Boost Soft-Start	V <sub>BUS</sub> < V <sub>BOOST</sub>
BST	Boost Operating Mode	V <sub>BAT</sub> > UVLO <sub>BST</sub> and SS Completed

Table 22. BOOST PWM OPERATING STATES

#### Startup

When the boost regulator is shut down, current flow is prevented from VBAT to VBUS, as well as reverse flow from VBUS to VBAT.

#### LIN State

When the boost is enabled, if  $V_{BAT} > UVLO_{BST}$ , the regulator first attempts to bring PMID within 400 mV of  $V_{BAT}$  using an internal 450 mA current source from VBAT (LIN State). If PMID has not achieved  $V_{BAT} - 400$  mV after 560 µs, a FAULT state is initiated.

#### SS State

When PMID >  $V_{BAT}$  – 400 mV, the boost regulator begins switching with a reduced peak current limit of about 50% of its normal current limit. The output slews up until V<sub>BUS</sub> is within 5% of its setpoint; at which time, the regulation loop is closed and the current limit is set to 100%.

If the output fails to achieve 95% of its setpoint (V<sub>BST</sub>) within 128  $\mu$ s, the current limit is increased to 100%. If the output fails to achieve 95% of its setpoint after this second 384  $\mu$ s period, a fault state is initiated.

#### **BST State**

This is the normal operating mode of the regulator. The regulator uses a scheme of calculated  $t_{OFF}$ , modulated  $t_{ON}$  with a minimum  $t_{ON}$ . The calculated  $t_{OFF}$  is proportional to  $V_{IN}$  /  $V_{OUT}$ , which keeps the regulator's switching frequency reasonably constant in CCM.

To ensure VBUS does not pump significantly above the regulation point, the boost switch remains off as long as the actual output voltage is greater than the regulation point.

### **Boost Faults**

If a BOOST fault occurs:

- 1. The STAT pin pulses.
- 2. OPA\_MODE bit is reset.
- 3. The power stage is in High–Impedance Mode.
- 4. The FAULT bits (REG 00[2:0]) are set per Table 23

#### **Restart After Boost Faults**

If boost was enabled with the OPA\_MODE bit and OTG\_EN=0, Boost Mode can only be enabled through subsequent I<sup>2</sup>C commands since OPA\_MODE is reset on boost faults. If OTG\_EN=1 and the OTG pin is still ACTIVE (see Table 21), the boost restarts after a 5.2 ms delay, as shown in Figure 41. If the fault condition persists, restart is attempted every 5 ms until the fault clears or an I<sup>2</sup>C command disables the boost.

Fault Bit		Bit		
B2	B2 B1 B0		Fault Description	
0	0	0	Normal (no fault)	
0	0	1	V <sub>BUS</sub> > VBUS <sub>OVP</sub>	
0	1	0	$V_{BUS}$ fails to achieve the voltage required to advance to the next state during soft-start or sustained (>50 $\mu$ s) current limit during the BST state.	
0	1	1	V <sub>BAT</sub> < UVLO <sub>BST</sub>	
1	0	0	N/A: This code does not appear.	
1	0	1	Thermal shutdown	
1	1	0	Timer fault; all registers reset.	
1	1	1	N/A: This code does not appear.	

Table 23. FAULT BITS DURING BOOST MODE

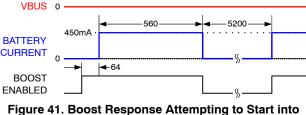


Figure 41. Boost Response Attempting to Start into VBUS Short Circuit (times in μs)

# VREG Pin

The 1.8 V regulated output on this pin can be disabled through I<sup>2</sup>C by setting the DIS\_VREG bit (REG 05[6]). VREG can supply up to 2 mA. This circuit, which is powered from PMID, is enabled only when PMID >  $V_{BAT}$ and does not drain current from the battery. During boost,  $V_{REG}$  is off. It is also off when the HZ\_MODE bit (REG 01[1])=1.

# Monitor Register (Reg 10h)

Additional status monitoring bits enable the host processor to have more visibility into the status of the IC. The monitor bits are real-time status indicators and are not internally debounced or otherwise time qualified.

The state of the MONITOR register bits listed in High–Impedance Mode is only valid when  $V_{BUS}$  is valid.

# I<sup>2</sup>C Interface

The FAN54005's serial interface is compatible with Standard, Fast, Fast Plus, and High–Speed Mode I<sup>2</sup>C–Bus specifications. The SCL line is an input and the SDA line is a bi–directional open–drain output; it can only pull down the bus when active. The SDA line only pulls LOW during data reads and signaling ACK. All data is shifted in MSB (bit 7) first.

# Slave Address

### Table 24. I<sup>2</sup>C SLAVE ADDRESS BYTE

Part Type	7	6	5	4	3	2	1	0
FAN54005	1	1	0	1	0	1	0	R/W

In hex notation, the slave address assumes a 0 LSB. The hex slave address for the FAN54005 is D4H and is D6H for all other parts in the family.

### **Bus Timing**

As shown in Figure 42, data is normally transferred when SCL is LOW. Data is clocked in on the rising edge of SCL. Typically, data transitions shortly at or after the falling edge of SCL to allow ample time for the data to set up before the next SCL rising edge.

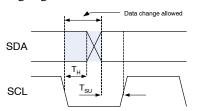


Figure 42. Data Transfer Timing

Each bus transaction begins and ends with SDA and SCL HIGH. A transaction begins with a START condition, which is defined as SDA transitioning from 1 to 0 with SCL HIGH, as shown in Figure 43.

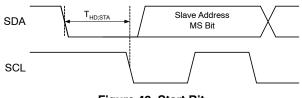
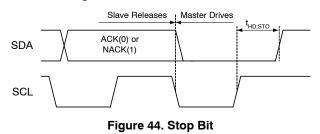


Figure 43. Start Bit

A transaction ends with a STOP condition, which is defined as SDA transitioning from 0 to 1 with SCL HIGH, as shown in Figure 44.



During a read from the FAN54005 (Figure 47), the master issues a Repeated Start after sending the register address and before resending the slave address. The Repeated Start is a 1–to–0 transition on SDA while SCL is HIGH, as shown in Figure 45.

### High-Speed (HS) Mode

The protocols for High–Speed (HS), Low–Speed (LS), and Fast–Speed (FS) Modes are identical except the bus speed for HS Mode is 3.4 MHz. HS Mode is entered when the bus master sends the HS master code 00001XXX after a start condition. The master code is sent in Fast or Fast Plus Mode (less than 1 MHz clock); slaves do not ACK this transmission.

The master then generates a repeated start condition (Figure 45) that causes all slaves on the bus to switch to HS Mode. The master then sends  $I^2C$  packets, as described above, using the HS Mode clock rate and timing.

The bus remains in HS Mode until a stop bit (Figure 44) is sent by the master. While in HS Mode, packets are separated by repeated start conditions (Figure 45).

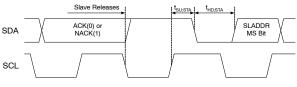


Figure 45. Repeated Start Timing

# **Read and Write Transactions**

The figures below outline the sequences for data read and write. Bus control is signified by the shading of the packet, defined as

Master Drives Bus					
and					
Slave Drives Bus	]				

All addresses and data are MSB first.

# Table 25. BIT DEFINITIONS FOR FIGURE 46 AND FIGURE 47

Symbol	Definition				
S	S START, see Figure 43				
А	A ACK. The slave drives SDA to 0 to acknowledge the preceding packet.				
Ā	NACK. The slave sends a 1 to NACK the preceding packet.				
R	R Repeated START, see Figure 45				
Р	STOP, see Figure 44				



Figure 46. Write Transaction

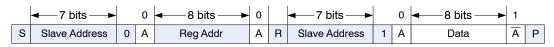


Figure 47. Read Transaction

# **Register Descriptions**

The nine FAN54005 user-accessible registers are defined in Table 26.

# Table 26. I<sup>2</sup>C REGISTER ADDRESS

Register			Address Bits						
Name	REG#	7	6	5	4	3	2	1	0
CONTROL0	00	0	0	0	0	0	0	0	0
CONTROL1	01	0	0	0	0	0	0	0	1
OREG	02	0	0	0	0	0	0	1	0
IC_INFO	03	0	0	0	0	0	0	1	1
IBAT	04	0	0	0	0	0	1	0	0
SP_CHARGER	05	0	0	0	0	0	1	0	1
SAFETY	06	0	0	0	0	0	1	1	0
MONITOR	10h	0	0	0	1	0	0	0	0

 Table 27. REGISTER BIT DEFINITIONS

 This table defines the operation of each register bit for all IC versions. Default values are in **bold** text.

CONTROLO         7       TMR_RST OTG         6       EN_STAT         6       EN_STAT         5:4       STAT         3       BOOST         2:0       FAULT         7:6       IINLIM         5:4       VLOWV         3       TE         3       TE         3       TE         3       TE         1       HZ_MODE         0       OPA_MODE         0       OREG         1       OTG_PL         0       OTG_EN         1       OTG_PL         1       OTG_PL         1       OTG_EN         1       OTG_PL         1       OTG_EN         1       OTG_EN         1       OTG_EN         1       OTG_EN         1       OTG_EN	Value	Name	Туре	Descrip	tion			
6       EN_STAT         6       EN_STAT         5:4       STAT         3       BOOST         2:0       FAULT         7:6       IINLIM         5:4       VLOWV         3       TE         3       TE         1       HZ_MODE         1       OPA_MODE         1       OREG         7:2       OREG         1       OTG_PL		OL0		Register Address: 00	Default Value=X1XX 0XXX			
5:4STAT5:4STAT3BOOST2:0FAULT7:6IINLIM5:4VLOWV3TE3TE1HZ_MODE1OPA_MODE1OPA_MODE1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1PN1:0REV	à 1	TMR_RST OTG	W	Writing a 1 resets the $t_{32S}$ timer; writing a 0 has	s no effect			
5:4STAT3BOOST2:0FAULTCONTEUTIINLIM5:4VLOWV3TE3TE3TE1HZ_MODE1OPA_MODE7:2OREG1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1OTG_PL1PN1:0REV			R	Returns the OTG pin level (1=HIGH)				
3BOOST2:0FAULTCONTEUTIINLIM5:4VLOWV5:4VLOWV3TE2CE1HZ_MODE1OPA_MODE7:2OREG1OTG_PL1OTG_EN1:0REV	0	EN_STAT	R/W	Prevents STAT pin from going LOW during cha faults	rrging; STAT pin still pulses to enunciate			
3BOOST2:0FAULTCONTEUTIINLIM5:4VLOWV5:4VLOWV3TE2CE1HZ_MODE1OPA_MODE7:2OREG1OTG_PL1OTG_EN1:0REV	1			Enables STAT pin LOW when IC is charging				
2:0       FAULT         CONTULI         7:6       IINLIM         5:4       VLOWV         5:4       VLOWV         3       TE         3       TE         1       HZ_MODE         0       OPA_MODE         7:2       OREG         1       OTG_PL         1       OTG_PL         1       OTG_PL         1       OTG_EN         7:5       Vendor Code         4:2       PN         1:0       REV	00	STAT	R	Ready				
2:0       FAULT         CONTULI         7:6       IINLIM         5:4       VLOWV         5:4       VLOWV         3       TE         3       TE         1       HZ_MODE         0       OPA_MODE         7:2       OREG         1       OTG_PL         1       OTG_PL         1       OTG_PL         1       OTG_EN         7:5       Vendor Code         4:2       PN         1:0       REV	01			Charge in progress				
2:0       FAULT         CONTULI         7:6       IINLIM         5:4       VLOWV         5:4       VLOWV         3       TE         3       TE         1       HZ_MODE         0       OPA_MODE         7:2       OREG         1       OTG_PL         1       OTG_N	10			Charge done				
2:0       FAULT         CONTULI         7:6       IINLIM         5:4       VLOWV         5:4       VLOWV         3       TE         3       TE         1       HZ_MODE         0       OPA_MODE         7:2       OREG         1       OTG_PL         1       OTG_N	11			Fault				
CONTULI         7:6       IINLIM         5:4       VLOWV         5:4       VLOWV         3       TE         3       TE         2       CE         1       HZ_MODE         0       OPA_MODE         7:2       OREG         1       OTG_PL         1       OTG_PL         1       OTG_PL         1       OTG_PL         7:5       Vendor Code         4:2       PN         1:0       REV	0	BOOST	R	IC is not in Boost Mode				
CONTULI         7:6       IINLIM         5:4       VLOWV         5:4       VLOWV         3       TE         3       TE         2       CE         1       HZ_MODE         0       OPA_MODE         7:2       OREG         1       OTG_PL         1       OTG_PL         1       OTG_PL         1       OTG_PL         7:5       Vendor Code         4:2       PN         1:0       REV	1			IC is in Boost Mode				
7:6IINLIM5:4VLOWV5:4VLOWV3TE3TE2CE1HZ_MODE0OPA_MODE7:2OREG1OTG_PL1OTG_EN0OTG_EN7:5Vendor Code4:2PN1:0REV		FAULT	R	Fault status bits: for Charge Mode, see Table 1	8			
5:4VLOWV5:4VLOWV3TE3TE2CE1HZ_MODE0OPA_MODE0OPA_MODE1OTG_PL1OTG_EN0OTG_EN1:0REV		OL1		Register Address: 01	Default Value=0111 0000 (70h)			
3TE2CE2CE1HZ_MODE0OPA_MODE7:2OREG1OTG_PL1OTG_EN0OTG_EN1:0REV	01	IINLIM	R/W	Input current limit, see Table 12	•			
2         CE           2         CE           1         HZ_MODE           0         OPA_MODE           7:2         OREG           1         OTG_PL           0         OTG_EN           7:5         Vendor Code           4:2         PN           1:0         REV	00	VLOWV	R/W	3.4 V	Weak battery voltage threshold			
2         CE           2         CE           1         HZ_MODE           0         OPA_MODE           7:2         OREG           1         OTG_PL           0         OTG_EN           7:5         Vendor Code           4:2         PN           1:0         REV	01			3.5 V				
2         CE           2         CE           1         HZ_MODE           0         OPA_MODE           7:2         OREG           1         OTG_PL           0         OTG_EN           7:5         Vendor Code           4:2         PN           1:0         REV	10			3.6 V				
2         CE           2         CE           1         HZ_MODE           0         OPA_MODE           7:2         OREG           1         OTG_PL           0         OTG_EN           7:5         Vendor Code           4:2         PN           1:0         REV	11			3.7 V				
1         HZ_MODE           0         OPA_MODE           0         OPA_MODE           7:2         OREG           1         OTG_PL           0         OTG_EN           0         OTG_EN           7:5         Vendor Code           4:2         PN           1:0         REV	0	TE	R/W	Disable charge current termination	•			
1         HZ_MODE           1         HZ_MODE           0         OPA_MODE           0         OPA_MODE           7:2         OREG           1         OTG_PL           0         OTG_EN           1         OTG_EN           7:5         Vendor Code           4:2         PN           1:0         REV	1			Enable charge current termination				
O         OPA_MODE           0         OPA_MODE           0         OPA_MODE           7:2         OREG           1         OTG_PL           0         OTG_EN           0         OTG_EN           7:5         Vendor Code           4:2         PN           1:0         REV	0	CE	R/W	Charger enabled.				
O         OPA_MODE           0         OPA_MODE           0         OPA_MODE           7:2         OREG           1         OTG_PL           0         OTG_EN           0         OTG_EN           7:5         Vendor Code           4:2         PN           1:0         REV	1			Charger disabled. The $T_{32S}$ timer is not susper	nded			
OREG           7:2         OREG           1         OTG_PL           0         OTG_EN           IL_INF         7:5           Yendor Code         4:2           1:0         REV	0	HZ_MODE	R/W	Not High-Impedance Mode	See Table 21			
OREG           7:2         OREG           1         OTG_PL           0         OTG_EN           IL_INF         7:5           Yendor Code         4:2           1:0         REV	1			High-Impedance Mode				
7:2     OREG       1     OTG_PL       0     OTG_EN       IC_INFC     IC       7:5     Vendor Code       4:2     PN       1:0     REV	0	OPA_MODE	R/W	Charge Mode				
7:2     OREG       1     OTG_PL       0     OTG_EN       IC_INFC     IC       7:5     Vendor Code       4:2     PN       1:0     REV	1			Boost Mode				
1         OTG_PL           0         OTG_EN           IC_INFO         Vendor Code           4:2         PN           1:0         REV				Register Address: 02	Default Value=0000 1010 (0Ah)			
0         OTG_EN           IC_INFO           7:5         Vendor Code           4:2         PN           1:0         REV	000010	OREG	R/W	Charger output "float" voltage; programmable f defaults to 000010 (3.54 V). See Table 8	rom 3.5 to 4.44 V in 20 mV increments;			
IC_INFO           7:5         Vendor Code           4:2         PN           1:0         REV	0	OTG_PL	R/W	OTG pin active LOW				
IC_INFO           7:5         Vendor Code           4:2         PN           1:0         REV	1			OTG pin active HIGH				
7:5         Vendor Code           4:2         PN           1:0         REV	0	OTG_EN	R/W	Disables OTG pin				
7:5         Vendor Code           4:2         PN           1:0         REV	1			Enables OTG pin				
4:2 PN 1:0 REV		)		Register Address: 03	Default Value=100101XX (9Xh)			
1:0 REV	100	Vendor Code	R	Identifies ON Semiconductor as the IC supplier	r			
	101	PN	R	Part number bits, see the Ordering Information	on on page 1			
ΙΒΔΤ	XX	REV	R	IC Revision bits				
	-		-	Register Address: 04 Default Value=1000 1001 (89h)				
7 RESET	1	RESET	W	Writing a 1 resets charge parameters, except t faults: writing a 0 has no effect; read returns 1	he Safety register (REG 06), to their de-			
6:4 IOCHARGE	000	IOCHARGE	R/W	Programs the maximum charge current when I	O_LEVEL (REG 05[5]) = 0. See Table 10			
7 RESET	XX 1	REV RESET	R	IC Revision bits         Register Address: 04       Default Value=1000 1001 (89h)         Writing a 1 resets charge parameters, except the Safety register (REG 06), to their de-				

 Table 27. REGISTER BIT DEFINITIONS

 This table defines the operation of each register bit for all IC versions. Default values are in **bold** text.

Bit	Name	Value	Туре	Description					
3	Reserved	1	R	Unused					
2:0	ITERM	001	R/W	Sets the current used for charging termination.	See Table 11				
SP_CH	ARGER			Register Address: 05	Default Value=001X X100				
7	Reserved	0	R	Unused					
6	DIS_VREG	0	R/W	1.8 V regulator is ON					
		1		1.8 V regulator is OFF					
5	IO_LEVEL	0	R/W	Output current is controlled by the IOCHARGE	bits				
		1		Output current control is limited to 34 mV acros	as R <sub>SNS</sub>				
4	SP	0	R	DIVC is not active ( $V_{BUS}$ is able to stay above	V <sub>SP</sub> )				
		1		DIVC has been detected and $V_{BUS}$ is being reg	gulated to V <sub>SP</sub>				
3	EN_LEVEL	0	R	DISABLE pin is LOW					
		1		DISABLE pin is HIGH					
2:0	VSP	100	R/W	DIVC input regulation voltage. See Table 13					
SAFET	Y			Register Address: 06	Default Value=0100 0000 (40h)				
7	Reserved	0	R	Bit disabled and always returns 0 when read back					
6:4	ISAFE	100	R/W	Sets the maximum I <sub>OCHARGE</sub> value used by the control circuit. See Table 14					
3:0	VSAFE	0000	R/W	Sets the maximum $V_{\mbox{\scriptsize OREG}}$ used by the control	circuit. See Table 15				
MONIT	OR			Register Address: 10h (16)					
7	ITERM_CMP		R	ITERM comparator output, 1 when VRSENSE	> See Table 11				
6	VBAT_CMP		R	Output of VBAT comparator 1 during charging indicates V <sub>BAT</sub> > V <sub>SHORT</sub> 1 during HZ_MODE indicates V <sub>BAT</sub> > V <sub>LOWV</sub> 1 during Boost Mode indicated V <sub>BAT</sub> > UVLO <sub>BST</sub>					
5	LINCHG		R	30 mA linear charger ON					
4	T_120		R	Thermal regulation comparator; when=1 and T_145=0, the charge current is limited to 22.1 mV across R <sub>SENSE</sub>					
3	ICHG		R	0 indicates the I <sub>OCHARGE</sub> loop is controlling the battery charge current					
2	IBUS		R	0 indicates the IBUS (input current) loop is controlling the battery charge current					
1	VBUS_VALID		R	1 indicates VBUS has passed validation and is capable of charging					
0	CV		R	1 indicates the constant-voltage loop (OREG) last V <sub>BUS</sub> plug in 0 indicates the constant-voltage loop (OREG)					
				last V <sub>BUS</sub> plug in 0 indicates the constant-voltage loop (OREG) VBUS plug in or the part is in the Charge Done					

# **PCB Layout Recommendations**

Bypass capacitors should be placed as close to the IC as possible. In particular, the total loop length for CMID should be minimized to reduce overshoot and ringing on the SW, PMID, and VBUS pins. All power and ground pins must be routed to their bypass capacitors, using top copper whenever possible. Copper area connecting to the IC should be maximized to improve thermal performance if possible.

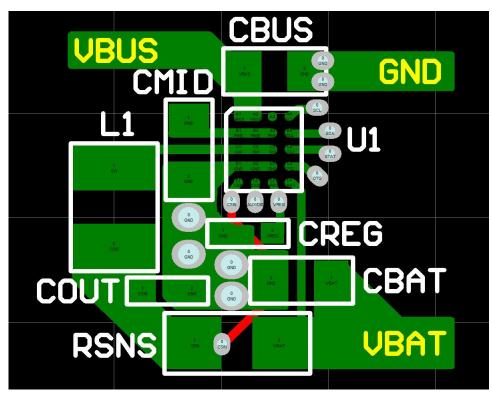


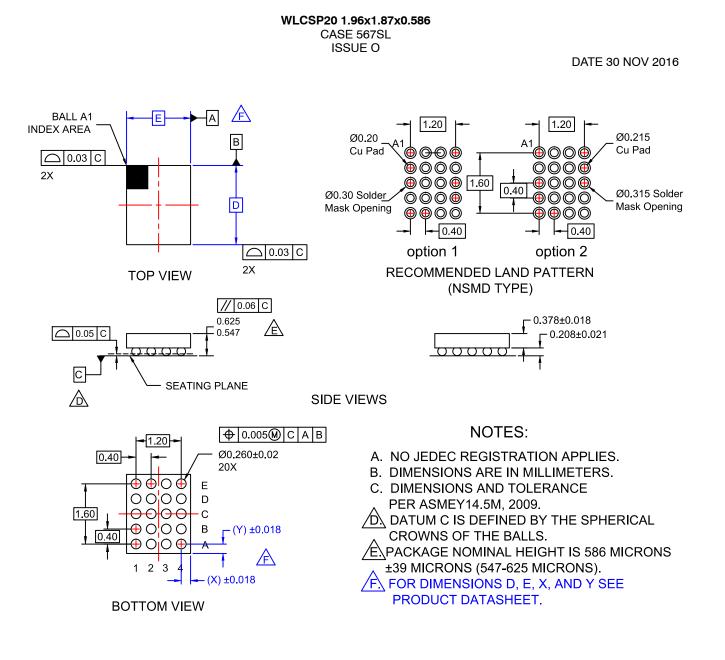
Figure 48. PCB Layout Recommendations

The table below pertains to the MOD information on the following page.

# **PRODUCT-SPECIFIC DIMENSIONS**

Product	D	E	Х	Y
FAN54005UCX	1.960 ±0.030 mm	1.870 ±0.030 mm	0.335 mm	0.180 mm





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